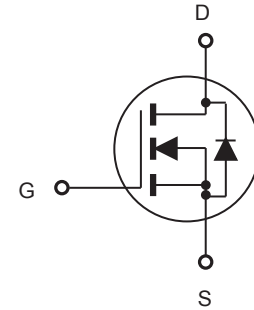


FEATURES

- 100V, 70A, $R_{DS(ON)} = 16m\Omega$ @ $V_{GS} = 10V$.
- Super high dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handling capability.
- Lead-free plating ; RoHS compliant.
- TO-220 & TO-263 package.



ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ C$ unless otherwise noted

| Parameter | Symbol | Limit | Units |
|---|----------------|------------|---------------|
| Drain-Source Voltage | V_{DS} | 100 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Drain Current-Continuous @ $T_C = 25^\circ C$ | I_D | 70 | A |
| Drain Current-Continuous @ $T_C = 100^\circ C$ | | 48 | A |
| Drain Current-Pulsed ^a | I_{DM} | 280 | A |
| Maximum Power Dissipation @ $T_C = 25^\circ C$ - Derate above $25^\circ C$ | P_D | 136 | W |
| | | 0.9 | W/ $^\circ C$ |
| Single Pulsed Avalanche Energy ^d | E_{AS} | 182 | mJ |
| Single Pulsed Avalanche Current ^d | I_{AS} | 27 | A |
| Operating and Store Temperature Range | T_J, T_{stg} | -55 to 175 | $^\circ C$ |

Thermal Characteristics

| Parameter | Symbol | Limit | Units |
|---|-----------------|-------|--------------|
| Thermal Resistance, Junction-to-Case | $R_{\theta JC}$ | 1.1 | $^\circ C/W$ |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 62.5 | $^\circ C/W$ |



CEP70N10/CEB70N10

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

| Parameter | Symbol | Test Condition | Min | Typ | Max | Units |
|---|--------------|--|-----|------|------|------------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS} = 0V, I_D = 250\mu A$ | 100 | | | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 100V, V_{GS} = 0V$ | | | 1 | μA |
| Gate Body Leakage Current, Forward | I_{GSSF} | $V_{GS} = 20V, V_{DS} = 0V$ | | | 100 | nA |
| Gate Body Leakage Current, Reverse | I_{GSSR} | $V_{GS} = -20V, V_{DS} = 0V$ | | | -100 | nA |
| On Characteristics^b | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{GS} = V_{DS}, I_D = 250\mu A$ | 2 | | 4 | V |
| Static Drain-Source On-Resistance | $R_{DS(on)}$ | $V_{GS} = 10V, I_D = 25A$ | | 13 | 16 | m Ω |
| Dynamic Characteristics^c | | | | | | |
| Forward Transconductance | g_{FS} | $V_{DS} = 25V, I_D = 25A$ | | 21 | | S |
| Input Capacitance | C_{iss} | $V_{DS} = 25V, V_{GS} = 0V, f = 1.0\text{ MHz}$ | | 3790 | | pF |
| Output Capacitance | C_{oss} | | | 240 | | pF |
| Reverse Transfer Capacitance | C_{rss} | | | 140 | | pF |
| Switching Characteristics^c | | | | | | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD} = 50V, I_D = 30A, V_{GS} = 10V, R_{GEN} = 5.6\Omega$ | | 27 | 54 | ns |
| Turn-On Rise Time | t_r | | | 10 | 20 | ns |
| Turn-Off Delay Time | $t_{d(off)}$ | | | 70 | 140 | ns |
| Turn-Off Fall Time | t_f | | | 13 | 26 | ns |
| Total Gate Charge | Q_g | $V_{DS} = 80V, I_D = 70A, V_{GS} = 10V$ | | 78 | 101 | nC |
| Gate-Source Charge | Q_{gs} | | | 20 | | nC |
| Gate-Drain Charge | Q_{gd} | | | 25 | | nC |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| Drain-Source Diode Forward Current | I_S | | | | 72 | A |
| Drain-Source Diode Forward Voltage ^b | V_{SD} | $V_{GS} = 0V, I_S = 25A$ | | | 1.3 | V |
| Notes : □ a.Repetitive Rating : Pulse width limited by maximum junction temperature b.Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$. □ c.Guaranteed by design, not subject to production testing. □ d.L = 0.5mH, $I_{AS} = 27A, V_{DD} = 25V, R_G = 25\Omega$, Starting $T_J = 25\text{ C}$ | | | | | | |

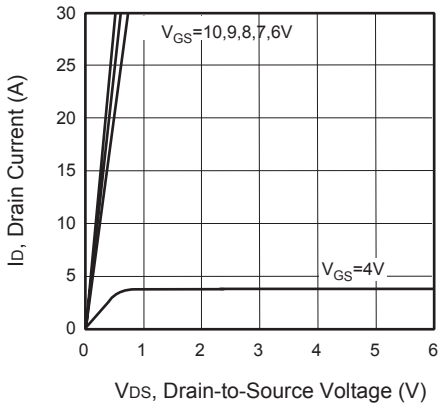


Figure 1. Output Characteristics

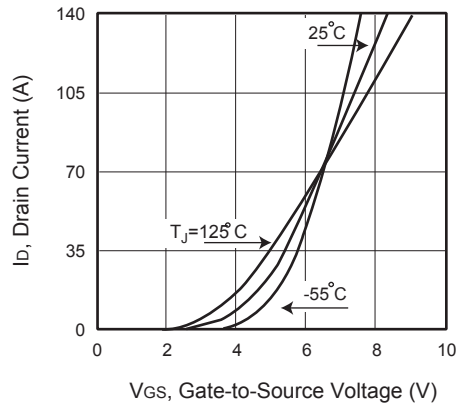


Figure 2. Transfer Characteristics

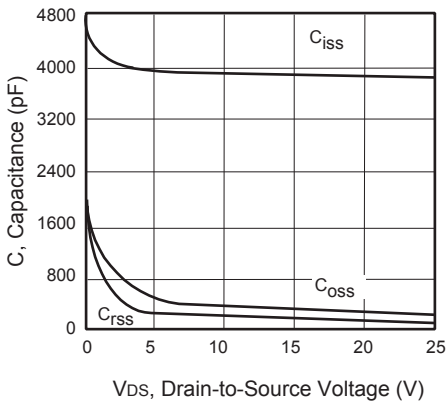


Figure 3. Capacitance

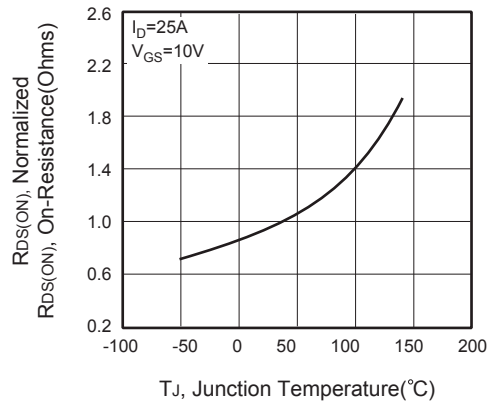


Figure 4. On-Resistance Variation with Temperature

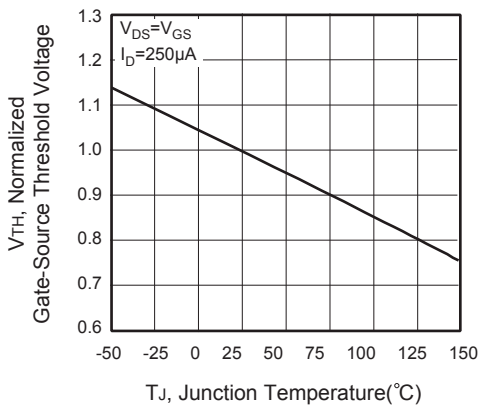


Figure 5. Gate Threshold Variation with Temperature

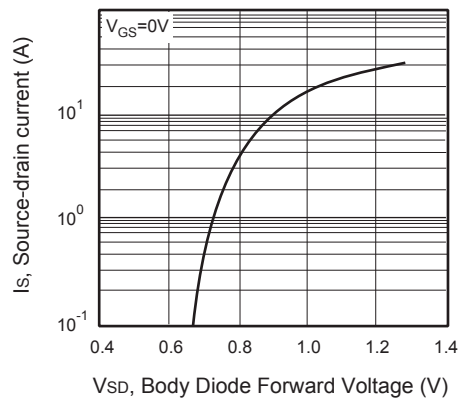


Figure 6. Body Diode Forward Voltage Variation with Source Current

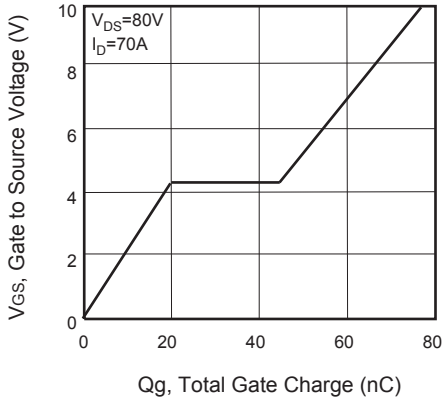


Figure 7. Gate Charge

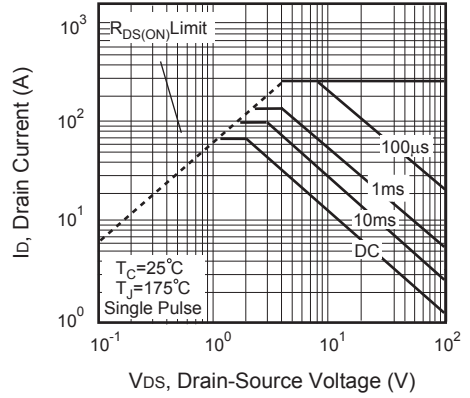


Figure 8. Maximum Safe Operating Area



Figure 9. Switching Test Circuit



Figure 10. Switching Waveforms

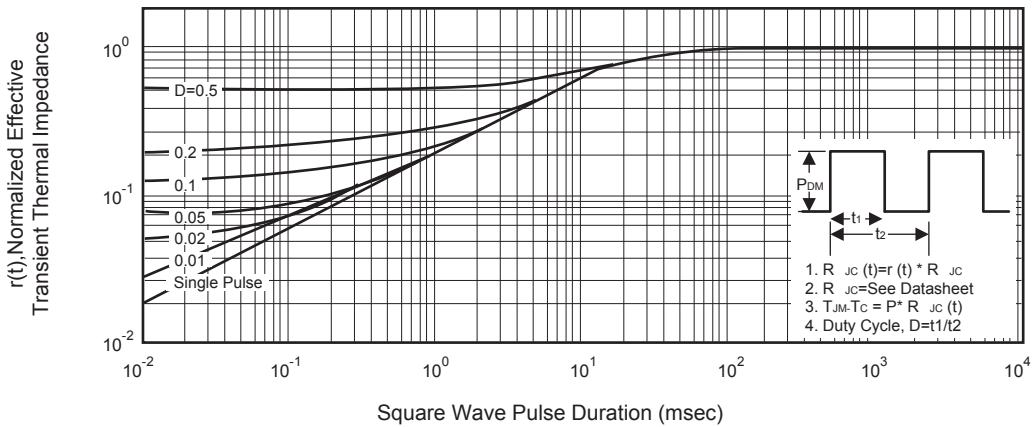


Figure 11. Normalized Thermal Transient Impedance Curve